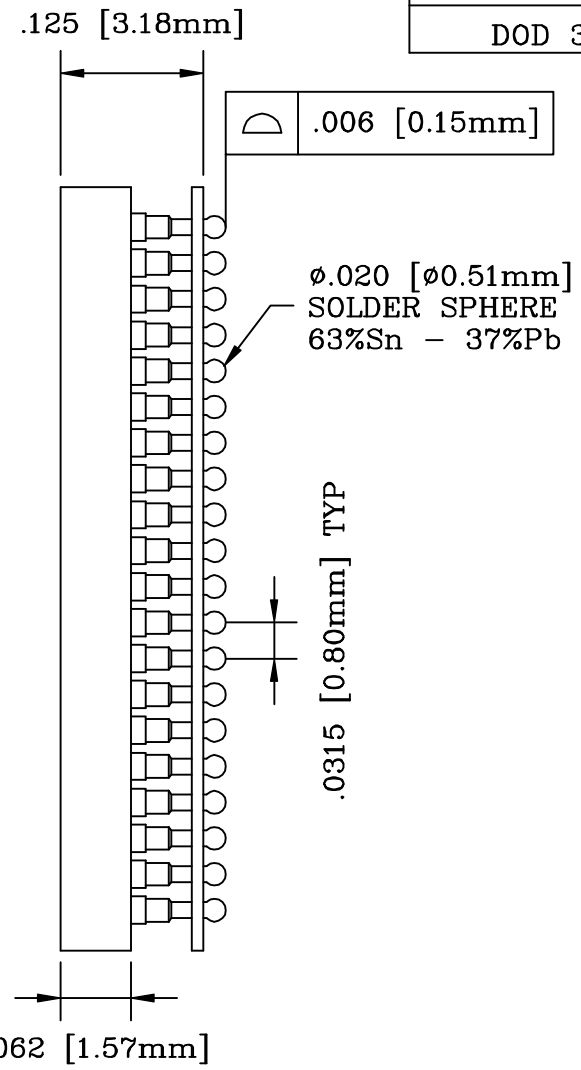
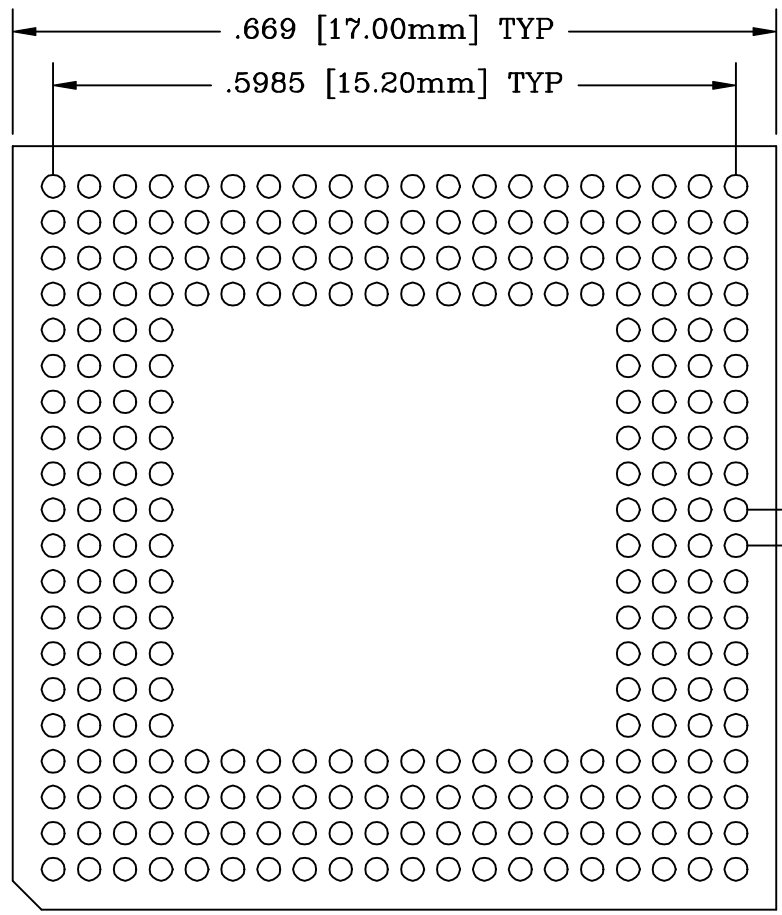


REV	DESCRIPTION	DATE	BY
A	NEW DRAWING	10/17/02	H.N.

F6744
DOD 36744

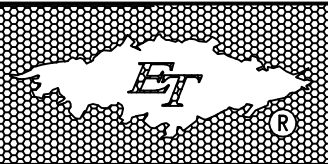


PACKAGE SPECIFICATIONS	
PIN COUNT	= 256
LEAD PITCH	= 0.80mm
GRID SIZE	= 20X20

NOTES:

- MATERIALS:**
INSULATORS: FR-4 GLASS EPOXY U.L. RATED 94V-0
TERMINAL: BRASS, C36000, ASTM-B-16
CONTACT: BeCu, C17200, ASTM-B-194
- PLATING:**
TERMINAL: .000010 [0.000254mm] MIN. GOLD OVER
.000050 [0.00127mm] MIN. NICKEL
CONTACT: .000030 [0.000762mm] MIN. GOLD OVER
.000050 [0.00127mm] MIN. NICKEL

ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE SPECIFIED



Emulation Technology, Inc.
— VLSI and SMT ADAPTERS and ACCESSORIES —

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SHEET: 1 OF 1	DATE: 10/17/02	REVISION: A	ASSEMBLY DRAWING
CHECKED: Perry Munroe	DRAWN: Hanh Nguyen	ITEM: BPE-256-6-020-B	
Scale 1:6	DO NOT SCALE DRAWING	DESCRIPTION: BPE-0256-6BG020-BL	